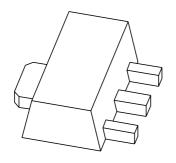
## **DISCRETE SEMICONDUCTORS**

## DATA SHEET



# PXT2907A PNP switching transistor

Product specification Supersedes data of 2002 Mar 20

2004 Dec 09





**Philips Semiconductors** 

## **PNP** switching transistor

#### **PXT2907A**

#### **FEATURES**

- High current (max. 600 mA)
- Low voltage (max. 60 V).

#### **APPLICATIONS**

• Switching and linear amplification.

#### **DESCRIPTION**

PNP switching transistor in a SOT89 plastic package. NPN complement: PXT2222A.

#### **MARKING**

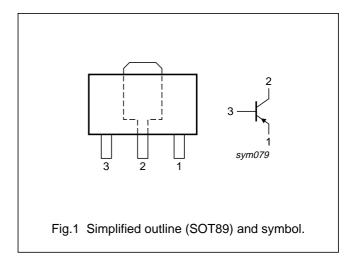
TYPE NUMBER	MARKING CODE(1)	
PXT2907A	*2F	

#### Note

- 1. \* = p: Made in Hong Kong.
  - \* = t: Made in Malaysia.
  - \* = W: Made in China.

#### **PINNING**

PIN	DESCRIPTION	
1	emitter	
2	collector	
3	base	



#### **ORDERING INFORMATION**

TYPE NUMBER	PACKAGE			
NAME DESCRIPTION		DESCRIPTION	VERSION	
PXT2907A	SC-62 plastic surface mounted package; collector pad for good heat transfer; 3 leads		SOT89	

## PNP switching transistor

**PXT2907A** 

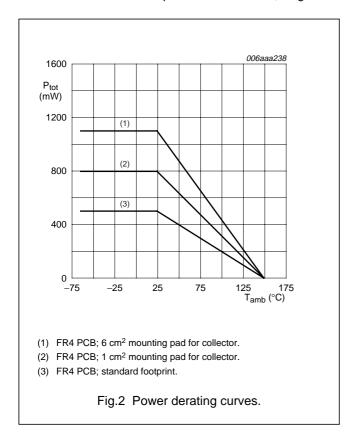
#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	-60	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	-60	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	-5	V
I <sub>C</sub>	collector current (DC)		_	-600	mA
I <sub>CM</sub>	peak collector current		_	-800	mA
I <sub>BM</sub>	peak base current		_	-200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C			
		note 1	_	0.5	W
		note 2	_	0.8	W
		note 3	_	1.1	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C

#### **Notes**

- 1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm<sup>2</sup>.



## PNP switching transistor

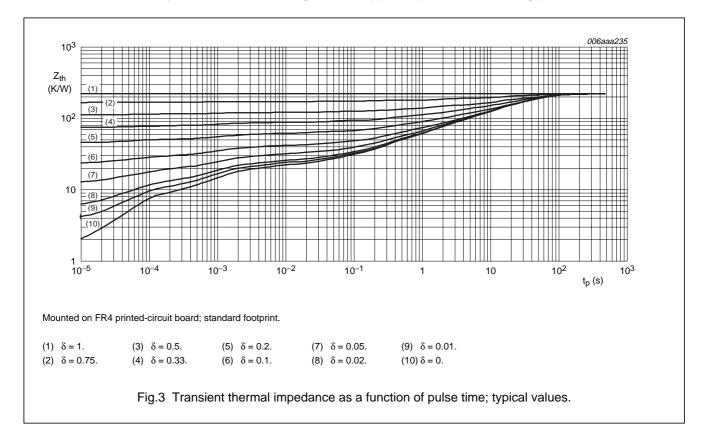
PXT2907A

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to	in free air		
	ambient	note 1	250	K/W
		note 2	156	K/W
		note 3	113	K/W
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point		30	K/W

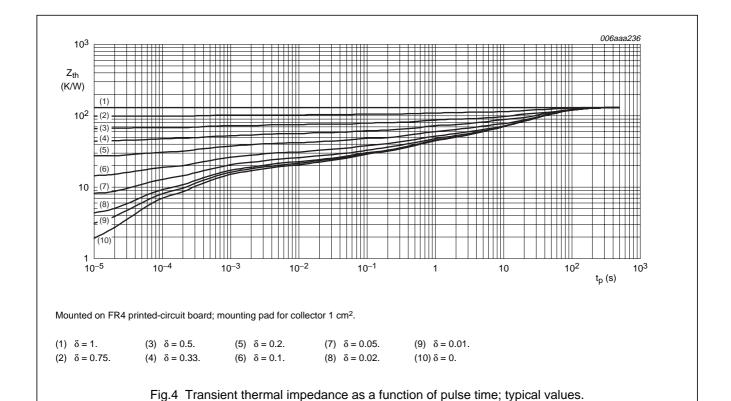
#### **Notes**

- 1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm<sup>2</sup>.



## PNP switching transistor

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006aaa237 10<sup>3</sup>  $Z_{th}$ (K/W) 10<sup>2</sup> (5) 10 (7) . 10<sup>-5</sup> 10-4  $10^{-3}$ 10-2 10<sup>-1</sup> 10<sup>2</sup> 10<sup>3</sup> 10 t<sub>p</sub> (s) Mounted on FR4 printed-circuit board; mounting pad for collector 6 cm<sup>2</sup>. (1)  $\delta = 1$ . (7)  $\delta = 0.05$ . (9)  $\delta = 0.01$ . (3)  $\delta = 0.5$ . (5)  $\delta = 0.2$ . (2)  $\delta = 0.75$ . (4)  $\delta = 0.33$ . (6)  $\delta = 0.1$ . (8)  $\delta = 0.02$ . (10)  $\delta = 0$ .

Fig.5 Transient thermal impedance as a function of pulse time; typical values.

## PNP switching transistor

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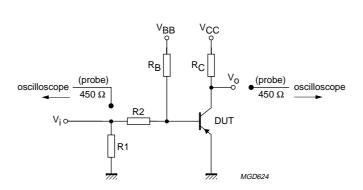
#### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$I_E = 0 \text{ A}; V_{CB} = -50 \text{ V}$	_	-10	nA
		$I_E = 0 \text{ A}; V_{CB} = -50 \text{ V}; T_{amb} = 125 ^{\circ}\text{C}$	_	-10	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$I_C = 0 \text{ A}; V_{EB} = -5 \text{ V}$	_	-50	nA
h <sub>FE</sub>	DC current gain	$I_C = -0.1 \text{ mA}; V_{CE} = -1 \text{ V}$	75	_	
		$I_C = -1 \text{ mA}; V_{CE} = -1 \text{ V}$	100	_	
		$I_C = -10 \text{ mA}; V_{CE} = -1 \text{ V}$	100	_	
		$I_C = -150 \text{ mA}; V_{CE} = -2 \text{ V}$	100	300	
		$I_C = -500 \text{ mA}; V_{CE} = -10 \text{ V}$	50	_	
V <sub>CEsat</sub>	collector-emitter saturation	$I_C = -150 \text{ mA}; I_B = -15 \text{ mA}$	_	-400	mV
	voltage	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	-1.6	V
V <sub>BEsat</sub> base-er	base-emitter saturation voltage	$I_C = -150 \text{ mA}; I_B = -15 \text{ mA}$	_	-1.3	V
		$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	-2.6	V
C <sub>c</sub>	collector capacitance	$I_E = i_e = 0 \text{ A}; V_{CB} = -10 \text{ V}; f = 1 \text{ MHz}$	_	8	pF
C <sub>e</sub>	emitter capacitance	$I_C = I_c = 0 \text{ A}; V_{EB} = -500 \text{ mV};$ f = 1 MHz	_	35	pF
f <sub>T</sub>	transition frequency	$I_C = -20 \text{ mA}; V_{CE} = -10 \text{ V};$ f = 100 MHz	200	_	MHz
Switching t	imes (between 10% and 90% leve	ls); (see Fig.6)	'	•	•
t <sub>on</sub>	turn-on time	$I_{Con} = -150 \text{ mA}; I_{Bon} = -15 \text{ mA};$	_	40	ns
t <sub>d</sub>	delay time	I <sub>Boff</sub> = 15 mA	_	12	ns
t <sub>r</sub>	rise time	1	_	30	ns
t <sub>off</sub>	turn-off time	1	_	365	ns
t <sub>s</sub>	storage time	1	_	300	ns
t <sub>f</sub>	fall time	1	_	65	ns

## PNP switching transistor

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$$\begin{split} &V_i = -9.5 \; V; \; T = 500 \; \mu s; \; t_p = 10 \; \mu s; \; t_r = t_f \leq 3 \; ns. \\ &R1 = 68 \; \Omega; \; R2 = 325 \; \Omega; \; R_B = 325 \; \Omega; \; R_C = 160 \; \Omega. \\ &V_{BB} = 3.5 \; V; \; V_{CC} = -29.5 \; V. \end{split}$$

Oscilloscope input impedance  $Z_i$  = 50  $\Omega$ .

Fig.6 Test circuit for switching times.

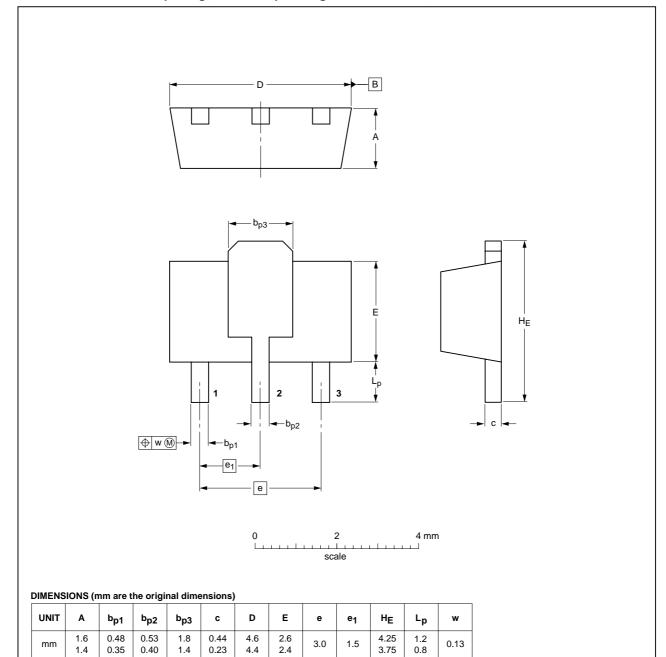
## PNP switching transistor

PXT2907A

#### **PACKAGE OUTLINE**

Plastic surface mounted package; collector pad for good heat transfer; 3 leads

SOT89



OUTLINE	E REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT89		TO-243	SC-62			<del>99-09-13</del> 04-08-03

#### PNP switching transistor

PXT2907A

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LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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